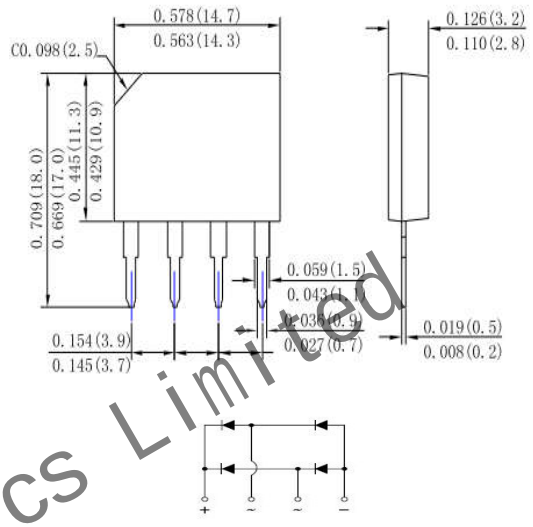
Single Phase 4.0Amp Glass passivated Bridge Rectifiers

GBP

Features

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Idea for printed circuit board
- Glass passivated Junction chip
- Low reverse leakage
- High forward surge current capability
- High temperature soldering guaranteed 250℃/10 seconds at terminals



Dimensions in inches and (millimeters)

Mechanical Data

Case : Molded plastic body
Terminals : Solder plated, solderable per MIL-STD-750,Method 2026
Polarity : Polarity symbol marking on body
Mounting Position : Any

Maximum Ratings And Electrical Characteristics

Ratings at 25℃ ambient temperature unless otherwise specified. Single phase half-wave 60Hz,resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	ARDGBP 4005FX0	ARDGBP 401FX0	ARDGBP 402FX0	ARDGBP 404FX0	ARDGBP 406FX0	ARDGBP 408FX0	ARDGBP 410FX0	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current with heatsink	$I_{(AV)}$	4.0							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	120.0							A
Rating for fusing (t=8.3ms, Ta=25℃)	I^2t	59.8							A^2s
Maximum instantaneous forward voltage at 4.0A	V_F	1.10							V
Maximum DC reverse current T_A =25℃ at rated DC blocking voltage T_A=125℃	I_R	5.0 500							uA
Typical junction capacitance (Note 1)	C_J	38.0							pF
Typical thermal resistance	$R_{\theta JA}$	55.0							°C/W
Operating junction and storage temperature range	T_J,T_{STG}	-55 to +150							°C

Note: 1.Measured at 1MHz and applied reverse voltage of 4.0V D.C.

Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

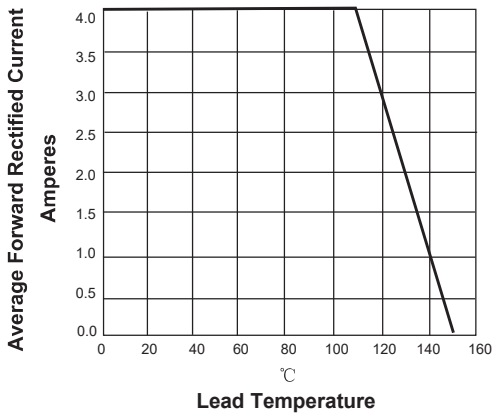


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

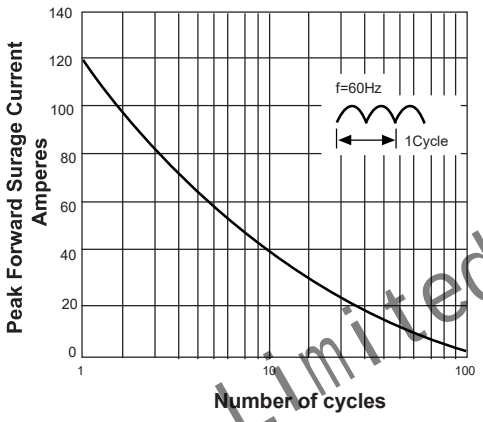


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

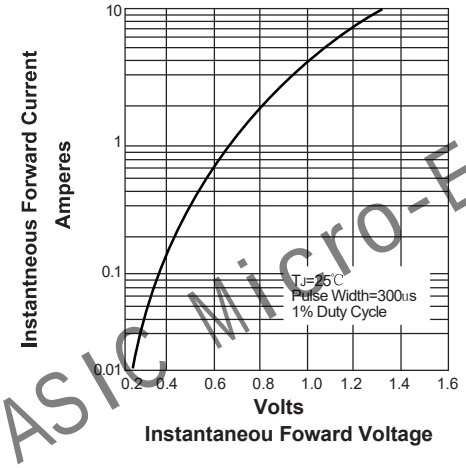


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS